MOTOROLA SEMICONDUCTOR TECHNICAL DATA

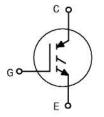
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Designer's™ Data Sheet

Insulated Gate Bipolar Transistor N-Channel Enhancement-Mode Silicon Gate

This Insulated Gate Bipolar Transistor (IGBT) uses an advanced termination scheme to provide an enhanced and reliable high voltage—blocking capability. Short circuit rated IGBT's are specifically suited for applications requiring a guaranteed short circuit withstand time. Fast switching characteristics result in efficient operation at high frequencies.

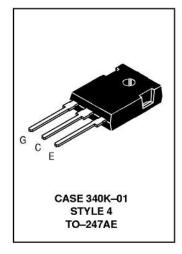
- Industry Standard High Power TO–247 Package with Isolated Mounting Hole
- High Speed E_{off}: 160 μJ/A typical at 125°C
- High Short Circuit Capability 10 μs minimum
- · Robust High Voltage Termination





Motorola Preferred Device

IGBT IN TO-247
20 A @ 90°C
28 A @ 25°C
1200 VOLTS
SHORT CIRCUIT RATED



MAXIMUM RATINGS (T_J = 25°C unless otherwise noted)

Rating		Value	Unit			
Collector–Emitter Voltage	VCES	1200	Vdc			
Collector–Gate Voltage (R _{GE} = 1.0 M Ω)	VcgR	1200	Vdc			
Gate-Emitter Voltage — Continuous	V _{GE}	±20	Vdc			
Collector Current — Continuous @ T _C = 25°C — Continuous @ T _C = 90°C — Repetitive Pulsed Current (1)	IC25 IC90 ICM	28 20 56	Adc Apk			
Total Power Dissipation @ T _C = 25°C Derate above 25°C	PD	174 1.39	Watts W/°C			
Operating and Storage Junction Temperature Range	T _J , T _{stg}	-55 to 150	°C			
Short Circuit Withstand Time ($V_{CC} = 720 \text{ Vdc}$, $V_{GE} = 15 \text{ Vdc}$, $T_{J} = 125^{\circ}\text{C}$, $R_{G} = 20 \Omega$)	t _{sc}	10	μs			
Thermal Resistance — Junction to Case – IGBT — Junction to Ambient	R ₀ JC R ₀ JA	0.7 35	°C/W			
Maximum Lead Temperature for Soldering Purposes, 1/8" from case for 5 seconds	TL	260	°C			
Mounting Torque, 6–32 or M3 screw	10	10 lbf•in (1.13 N•m)				

Pulse width is limited by maximum junction temperature. Repetitive rating.

Designer's Data for "Worst Case" Conditions — The Designer's Data Sheet permits the design of most circuits entirely from the information presented. SOA Limit curves — representing boundaries on device characteristics — are given to facilitate "worst case" design.

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Preferred devices are Motorola recommended choices for future use and best overall value.

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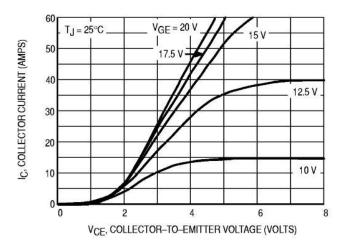
ELECTRICAL CHARACTERISTICS ($T_J = 25$ °C unless otherwise noted)

Cha	aracteristic	Symbol	Min	Тур	Max	Unit
OFF CHARACTERISTICS						
Collector–to–Emitter Breakdown V (V _{GE} = 0 Vdc, I _C = 25 μAdc) Temperature Coefficient (Positive		V(BR)CES	1200 —	 870	*—*	Vdc mV/°C
Emitter-to-Collector Breakdown Voltage (V _{GE} = 0 Vdc, I _{EC} = 100 mAdc)		V _{(BR)ECS}	25	_	00—01	Vdc
Zero Gate Voltage Collector Current (VCE = 1200 Vdc, VGE = 0 Vdc) (VCE = 1200 Vdc, VGE = 0 Vdc, TJ = 125°C)		ICES	=	=	100 2500	μAdc
Gate-Body Leakage Current ($V_{GE} = \pm 20 \text{ Vdc}, V_{CE} = 0 \text{ Vdc}$)		^I GES	-	-	250	nAdc
ON CHARACTERISTICS (1)				•		
Collector-to-Emitter On-State Vol (VGE = 15 Vdc, I _C = 10 Adc) (VGE = 15 Vdc, I _C = 10 Adc, T _J (VGE = 15 Vdc, I _C = 20 Adc)		VCE(on)	Ξ	2.42 2.36 2.90	3.54 — 4.99	Vdc
Gate Threshold Voltage (VCE = VGE, IC = 1.0 mAdc) Threshold Temperature Coefficie	ent (Negative)	V _{GE(th)}	4.0	6.0 10	8.0	Vdc mV/°C
Forward Transconductance (VCE =	= 10 Vdc, I _C = 20 Adc)	9fe	-	12	(1)	Mhos
YNAMIC CHARACTERISTICS			<u></u>		***	
Input Capacitance	(V _{CE} = 25 Vdc, V _{GE} = 0 Vdc, f = 1.0 MHz)	C _{ies}		1860	N - 23	pF
Output Capacitance		Coes	-	122	W	
Transfer Capacitance		C _{res}	-	29	M = - / / / / / / / / / / / / / / / / / /	
WITCHING CHARACTERISTICS (1)		94		950	05
Turn-On Delay Time		^t d(on)	_	88	3 — 6	ns
Rise Time	$(V_{CC}=720 \text{ Vdc}, I_{C}=20 \text{ Adc}, V_{GE}=15 \text{ Vdc}, L=300 \mu\text{H}$ $R_{G}=20 \Omega$) Energy losses include "tail"	tr	-	103	22 — 25	
Turn-Off Delay Time		^t d(off)	12-27	190	8—8	
Fall Time		t _f	<u>12—12</u>	284	8 — 8	
Turn-Off Switching Loss		E _{off}	_	1.65	2.75	mJ
Turn-On Delay Time	(V _{CC} = 720 Vdc, I _C = 20 Adc, V _{GE} = 15 Vdc, L = 300 μH R _G = 20 Ω, T _J = 125°C) Energy losses include "tail"	^t d(on)	_	83	*—*	ns
Rise Time		t _r	_	107	3 — 6	
Turn-Off Delay Time		td(off)	-	216	32 — 6	
Fall Time		tf	-	494	38 — 6	
Turn-Off Switching Loss		E _{off}	-	3.19	35 — 6	mJ
Gate Charge	(V _{CC} = 720 Vdc, I _C = 20 Adc, V _{GE} = 15 Vdc)	QT	122	62	8—8	nC
		Q ₁	-	21	*s	
		Q ₂	(<u></u>)	25	8 — 8	
NTERNAL PACKAGE INDUCTANO	E			-		
Internal Emitter Inductance (Measured from the emitter lead	0.25" from package to emitter bond pad)	LE	<u></u> -	13	<u> </u>	nH

⁽¹⁾ Pulse Test: Pulse Width ≤ 300 μs, Duty Cycle ≤ 2%.

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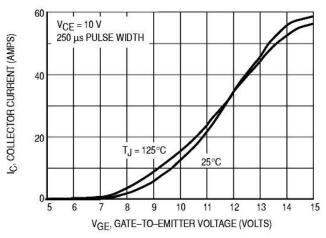
TYPICAL ELECTRICAL CHARACTERISTICS



T_J = 125°C V_{GE} = 20 V 15 V - 17.5 V - 17.5 V - 10 V -

Figure 1. Output Characteristics

Figure 2. Output Characteristics



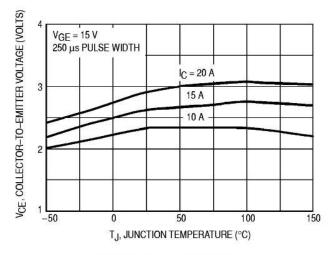
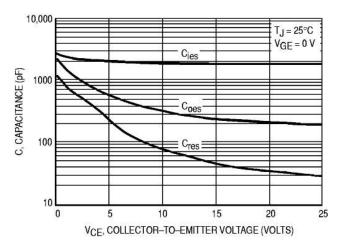


Figure 3. Transfer Characteristics

Figure 4. Collector-to-Emitter Saturation Voltage versus Junction Temperature



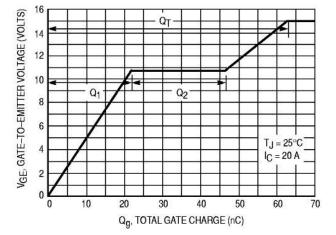


Figure 5. Capacitance Variation

Figure 6. Gate-to-Emitter Voltage versus Total Charge

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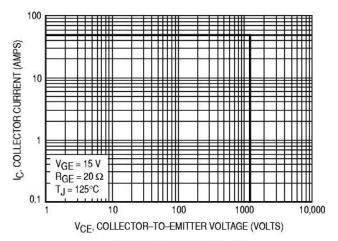


Figure 7. Reverse Biased Safe Operating Area

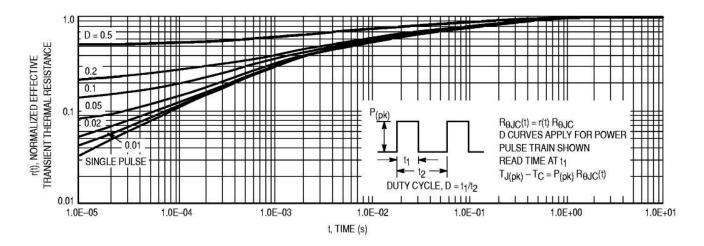
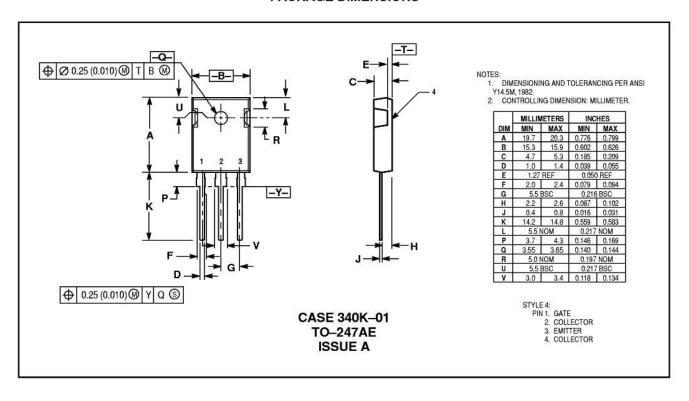


Figure 8. Thermal Response

4 Motorola IGBT Device Data

PACKAGE DIMENSIONS



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